

ChipEx2026 - Call for Paper Submission Form

LOGO (optional)	Company Name:	Web Site:		
Presenter Name:	Mobile number:	Email:		
• From ChipEx2026 key topics I would like to speak about:	Presentation title:			
Please mark your main Topic in BOLD :				
 Silicon Architectures for the Era of Advanced Intelligence Power Management & Signal Integrity Analog Design, RF and Sensors Physical Design and Manufacturability IP for SoC & NoC Verification, Simulation, Testing & Security Manufacturing, Post Silicon processes (including HW testing and packaging) Emerging and creative design technologies Users Track – sharing user experience with industry colleagues 				
Company Profile (up to 5 lines):				



The Problem/Market no	eed Addressed (up to 5	ines):	
The innovative technology	ogy you wish to present	– please elaborate (up to 1	.0 lines):
Why do you consider it	to be new and interesti	ng (up to 5 lines):	
Was this paper previou	sly published or simulta	neously under review by ar	nother conference:
Anything else you woul	d like to add:		
=	_	ganizers of ChipEx2026 fro	-
		e content of my document	s/presentation to
the conference audience	or for publishing it in the	neir web site.	
Name:		Signature:	